onsemi

MOSFET - Power, Single N-Channel, SO8-FL 30 V, 0.62 mΩ, 433 A

NTMFS0D6N03C

Features

- Advanced Package (5x6mm) with Excellent Thermal Conduction
- Ultra Low R_{DS(on)} to Improve System Efficiency
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- ORing
- Motor Drive
- Power Load Switch
- Battery Management and Protection

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

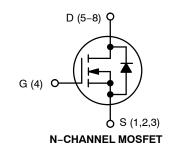
| Parameter | | | Symbol | Value | Unit |
|---|----------------------|---------------------------|-----------------------------------|----------------|------|
| Drain-to-Source Voltage | | | V _{DSS} | 30 | V |
| Gate-to-Source Voltage | | | V _{GS} | ±20 | V |
| Continuous Drain | Steady | T _C = 25°C | Ι _D | 433 | А |
| Current R _{0JC} (Note 2) | | T _C =100°C | | 306 | |
| Power Dissipation $R_{\theta JC}$ (Note 2) | State | T _C = 25°C | PD | 200 | W |
| Continuous Drain | | $T_A = 25^{\circ}C$ | ۱ _D | 60 | А |
| Current R _{θJA} (Notes 1, 2) | Steady | T _A = 100°C | | 42 | |
| Power Dissipation $R_{\theta JA}$ (Notes 1, 2) | State | T _A = 25°C | P _D | 3.9 | W |
| Pulsed Drain Current | T _A = 25° | C, t _p = 10 μs | I _{DM} | 900 | А |
| Source Current (Body Diode) | | | ۱ _S | 156 | А |
| Single Pulse Drain-to-Source Avalanche Energy (I _L = 45.4 A _{pk}) | | | E _{AS} | 1032 | mJ |
| Operating Junction and Storage Temperature Range | | | T _J , T _{STG} | –55 to +175 | °C |
| Lead Temperature for Soldering Purposes (1/8" from case for 10 s) | | | ΤL | 260 | °C |

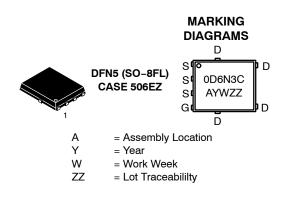
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using 1 in² pad, 2 oz Cu pad.

The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

| V _{(BR)DSS} | R _{DS(ON)} MAX | I _D MAX |
|----------------------|---|--------------------|
| 30 V | $0.62~\mathrm{m}\Omega @~10~\mathrm{V}$ | 433 A |
| 30 V | 0.9 mΩ @ 4.5 V | 400 Å |





ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

THERMAL RESISTANCE MAXIMUM RATINGS

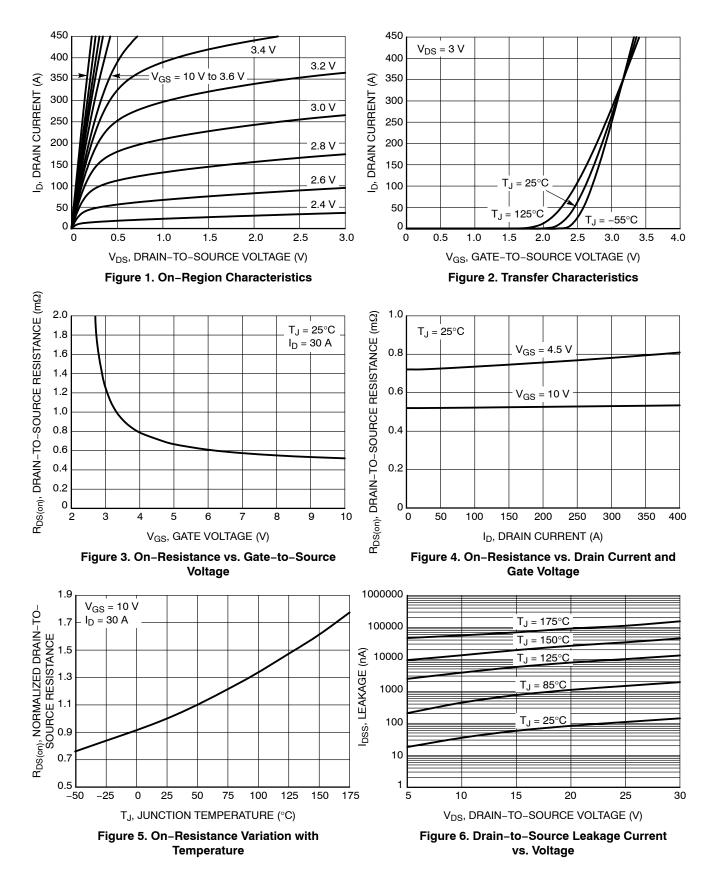
| Parameter | Symbol | Value | Unit |
|---|---------------------|-------|------|
| Junction-to-Case - Steady State (Note 1) | $R_{	ext{	heta}JC}$ | 0.8 | °C/W |
| Junction-to-Ambient - Steady State (Note 1) | $R_{\theta JA}$ | 38 | C/VV |
| Junction-to-Ambient - Steady State (Note 2) | $R_{\theta JA}$ | 134 | °C/W |

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

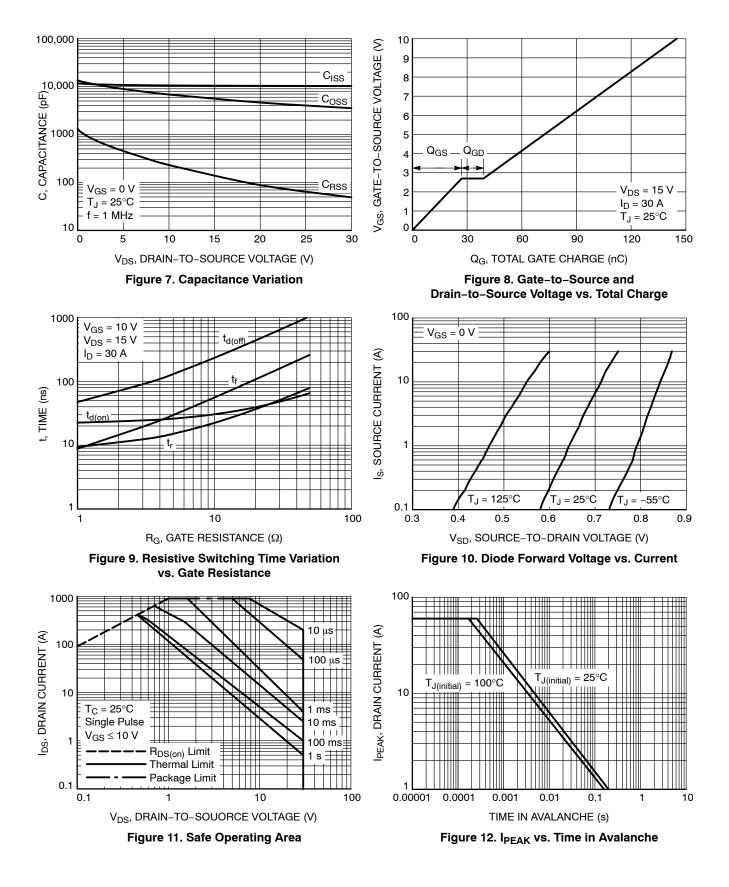
| Parameter | Symbol | Test Condition | | Min | Тур | Max | Unit |
|--|--|--|------------------------|----------|-------|------|----------|
| OFF CHARACTERISTICS | - | | | | | | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | V_{GS} = 0 V, I _D = 250 µA | | 30 | | | V |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | V _{(BR)DSS} / T _J | $I_D = 250 \ \mu A. ref to 25^{\circ}C$ | | | 12 | | mV/°C |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V, V _{DS} = 30 V | $T_J = 25^{\circ}C$ | | | 1.0 | μΑ |
| | | | T _J = 125°C | | | 100 | |
| Gate-to-Source Leakage Current | I _{GSS} | V _{DS} = 0 V, V _{GS} = 20 V | | | | 100 | nA |
| ON CHARACTERISTICS (Note 3) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | V _{GS} = V _{DS} , I _E | ₀ = 280 μA | 1.3 | | 2.2 | V |
| Threshold Temperature Coefficient | V _{GS(TH)} /T _J | I _D = 280 μA. r | ef to 25°C | | -5.7 | | mV/°C |
| Drain-to-Source On Resistance | R _{DS(on)} | V _{GS} = 10 V, I _D = 30 A | | | 0.52 | 0.62 | mΩ |
| Drain-to-Source On Resistance | R _{DS(on)} | V _{GS} = 4.5 V, | I _D = 30 A | | 0.72 | 0.9 | mΩ |
| Forward Transconductance | 9 _{FS} | $V_{DS} = 3 \text{ V}, \text{ I}_{D} = 30 \text{ A}$ | | | 150 | | S |
| Gate Resistance | R _G | $T_A = 25^{\circ}C$ | | | 0.4 | | Ω |
| CHARGES AND CAPACITANCES | | | | | 1 | | <u> </u> |
| Input Capacitance | C _{ISS} | V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz | | | 10500 | | pF |
| Output Capacitance | C _{OSS} | | | | 5740 | | |
| Reverse Transfer Capacitance | C _{RSS} | | | | 161 | | |
| Total Gate Charge | Q _{G(TOT)} | V _{GS} = 4.5 V, V _{DS} = 15 V; I _D = 30 A | | | 65 | | nC |
| Threshold Gate Charge | Q _{G(TH)} | | | | 16 | | |
| Gate-to-Drain Charge | Q _{GD} | | | | 12 | | |
| Gate-to-Source Charge | Q _{GS} | | | | 27 | | |
| Total Gate Charge | Q _{G(TOT)} | V _{GS} = 10 V, V _{DS} = 15 V; I _D = 30 A | | | 145 | | nC |
| SWITCHING CHARACTERISTICS (Note 4 |) | | | | | | <u>I</u> |
| Turn–On Delay Time | t _{d(ON)} | | | | 24 | | <u> </u> |
| Rise Time | t _r | V_{GS} = 10 V, V_{DS} = 15 V, I _D = 30 A, R _G = 3.0 Ω | | | 12 | | - ns |
| Turn-Off Delay Time | t _{d(OFF)} | | | | 89 | | |
| Fall Time | t _f | | | | 19 | | |
| DRAIN-SOURCE DIODE CHARACTERIS | | | | <u>n</u> | 1 1 | | <u> </u> |
| Forward Diode Voltage | V _{SD} | V _{GS} = 0 V, I _S = 30 A | T _J = 25°C | | 0.75 | 1.2 | [|
| Ğ | | | T _J = 125°C | | 0.60 | | V |
| Reverse Recovery Time | t _{RR} | V _{GS} = 0 V, dIS/dt = 100 A/μs, V _{DS} = 15 V, I _S = 30 A | | | 97 | | ns |
| Reverse Recovery Charge | Q _{RR} | | | | 135 | | nC |

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



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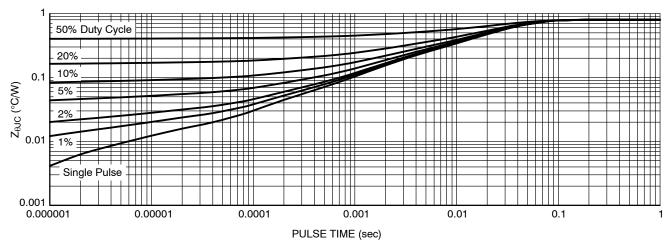


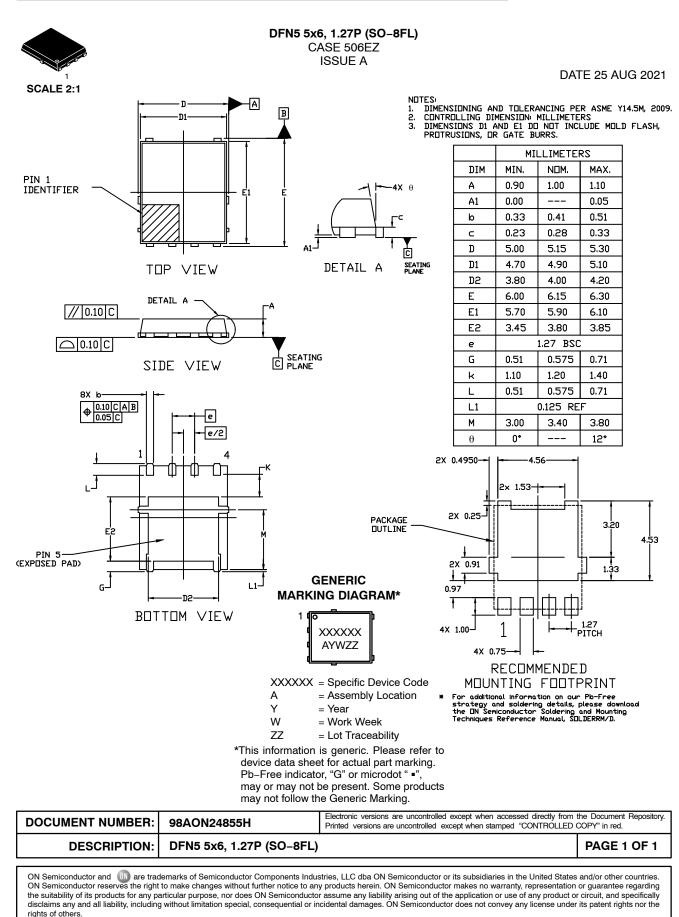
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

| Device | Marking | Package | Shipping [†] |
|-----------------|---------|-------------------|-----------------------|
| NTMFS0D6N03CT1G | 0D6N3C | DFN5 (Pb–Free) | 1500 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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